## **MIC2039**



### High-Accuracy, High-Side, Adjustable Current Limit Power Switch

## **General Description**

The MIC2039 is a high-side MOSFET power distribution switch providing increased system reliability by using 5% current-limit accuracy.

The MIC2039 has an operating input voltage range from 2.5V to 5.5V, is internally current limited, and has thermal shutdown to protect the device and system. The MIC2039 is offered with either active-high or active-low logic level enable input controls. It has an open drain fault status output flag with a built-in 32ms delay that asserts low during overcurrent or thermal-shutdown conditions.

The MIC2039 switches feature an adjustable output current limit that is resistor programmable from 0.2A to 2.5A. The MIC2039 switch also offers a unique, Kickstart feature that allows momentary high-current surges up to the secondary current limit (I<sub>LIMIT\_2nd</sub>) during startup or while operating in steady state. This is useful for charging loads with high inrush currents, such as capacitors. After an overcurrent condition is established, these switches enter into a constant current-limit mode unless the die temperature exceeds the thermal-shutdown specification.

The MIC2039 is available in 6-pin SOT-23 and 6-pin 2mm  $\times$  2mm thin DFN packages. The MIC2039 has an operating junction temperature range of  $-40^{\circ}$ C to  $+125^{\circ}$ C.

Datasheets and support documentation are available on Micrel's web site at: <a href="https://www.micrel.com">www.micrel.com</a>.

### **Features**

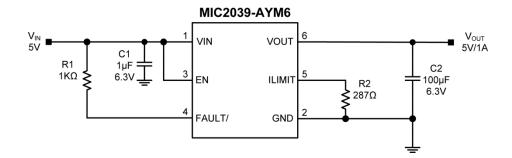
- ±5% current limit accuracy
- Input supply range from 2.5V to 5.5V
- Low quiescent current: 100µA typical (switch ON)
- 75mΩ typical R<sub>DS(ON)</sub> at 5.0V
- 0.2A to 2.5A adjustable output current
- Kickstart momentary secondary current-limit threshold (120ms period)
- Soft-start functionality
- Undervoltage lockout (UVLO)
- Fast 10µs short-circuit response time (non-Kickstart options)
- · Fault status output flag
- Logic-controlled enable (active-high, active-low)
- Thermal shutdown
- Pin compatible with the MIC2009/MIC2019
- 6-pin 2mm × 2mm thin DFN and 6-pin SOT-23 packages
- Junction temperature range from –40°C to +125°C

Revision 1.3

## **Applications**

- USB peripherals and USB 2.0/3.0 compatible
- DTV/STB
- Notebooks and consumer electronics
- General-purpose power distribution

## **Typical Application**



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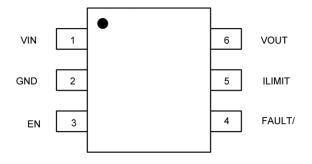
## **Ordering Information**

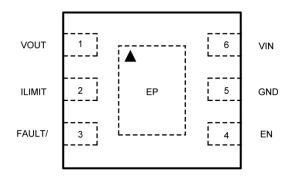
Part Number	Top Mark <sup>(1)</sup>	Current Limit	Enable	Kickstart	Package	
MIC2039AYM6	<u>39A</u> A	Adjustable	Active High	No	SOT-23-6L	
MIC2039BYM6	<u>39B</u> B	Adjustable	Active Low	No	SOT-23-6L	
MIC2039AYMT	3A9	Adjustable	Active High	No	6-pin 2mm x 2mm Thin DFN <sup>(2)</sup>	
MIC2039BYMT	B39	Adjustable	Active Low	No	6-pin 2mm x 2mm Thin DFN <sup>(2)</sup>	
MIC2039EYM6	<u>39A</u> E	Adjustable	Active High	Yes	SOT-23-6L	
MIC2039FYM6	<u>39A</u> F	Adjustable	Active Low	Yes	SOT-23-6L	
MIC2039EYMT	D39	Adjustable	Active High	Yes	6-pin 2mm x 2mm Thin DFN <sup>(2)</sup>	
MIC2039FYMT	F39	Adjustable	Active Low	Yes	6-pin 2mm x 2mm Thin DFN <sup>(2)</sup>	

### Note:

- 1. Under-bar symbol ( \_ ) may not be to scale.
- 2. Thin DFN is a GREEN RoHS-compliant package. Lead finish is NiPdAu. Mold compound is Halogen Free.

## **Pin Configuration**





SOT-23 6-pin (M6) Top View

2mm x 2mm 6-pin Thin DFN (MT)<sup>(3)</sup> (Top View)

### Notes:

3. Thin DFN ▲ = Pin 1 identifier.

# **Pin Description**

Pin Nu	umber		
SOT-23-6L	6-Pin 2mm x 2mm Thin DFN	Pin Name	Pin Function
1	6	VIN	Input: Power switch and logic supply input.
2	5	GND	Ground: Input and output return pin.
3	4	EN	Enable (Input): Logic compatible, enable control input that allows switch turn-on/off. Do not leave the EN pin floating.
4	3	FAULT/	Fault Status Flag (Output): Active-low, open-drain output. A logic low state indicates an overcurrent or thermal shutdown condition. An overcurrent condition must last longer than $t_{\text{FAULT}}$ / to assert FAULT/. A pull-up resistor (10k $\Omega$ recommended) to an external supply is required.
5	2	ILIMIT	Current Limit Set: Current limit adjust setting. Connect a resistor from this pin to GND to set the current limit, but do not leave the ILIMIT pin floating.
6	1	VOUT	Switch Output: Power switch output.
_	EP	ePad	Exposed Pad: Exposed pad on bottom of package. Connect to electrical ground for optimum thermal dissipation.

# Absolute Maximum Ratings<sup>(4)</sup>

0.3V to +6V 0.3V to +6V
_0 3\/ to ±6\/
. 0.5 1 10 10 1
0.3V to +6V
0.3V to +6V
0.3V to +6V
25mA
ernally Limited
260°C
5°C to +150°C
3kV
300V

# Operating Ratings<sup>(5)</sup>

Supply Voltage (V <sub>IN</sub> )	+2.5V to +5.5V
V <sub>EN</sub> , V <sub>FAULT/</sub>	0.3V to +5.5V
V <sub>ILIMIT</sub> , V <sub>OUT</sub>	0.3V to V <sub>IN</sub>
Junction Temperature (T <sub>J</sub> )	40°C to +125°C
Package Thermal Resistance	
SOT-23-6 (θ <sub>JA</sub> )	177.2°C/W
6-pin 2mm $\times$ 2mm Thin DFN ( $\theta_{JA}$ ) .	90°C/W

## Electrical Characteristics<sup>(7)</sup>

 $V_{IN} = V_{EN} = 5V$ ;  $C_{IN} = 1 \mu F$ ;  $T_J = 25 ^{\circ}C$ . **Bold** values indicate  $-40 ^{\circ}C \le T_A \le +85 ^{\circ}C$ , unless noted.

Symbol	Parameter	Condition			Тур.	Max.	Units
Power Su	pply Input						
V <sub>IN</sub>	Input Voltage Range			2.5		5.5	V
	Input Supply Undervoltage	V <sub>IN</sub> rising		2.0	2.25	2.5	V
$V_{UVLO}$	Lockout Threshold	V <sub>IN</sub> falling		1.9	2.15	2.4	V
V <sub>UVLOHYS</sub>	Input Supply Undervoltage Lockout Threshold Hysteresis	V <sub>IN</sub> rising or V <sub>IN</sub> falling			100		mV
	Supply Current	Switch OFF	Active-high Enable (A): $V_{EN} = 0V$ , $V_{IN} = 5V$	0.75	5		
		$(I_{OUT} = 0A)$	Active-low Enable (B): V <sub>EN</sub> = V <sub>IN</sub> = 5V				μА
I <sub>DD</sub>		Switch ON	Active-high Enable (A): $V_{EN} = 1.5V$ , $V_{IN} = 5V$		100	300	
		(I <sub>OUT</sub> = 0A)	Active-low Enable (B): $V_{EN} = 0V$ , $V_{IN} = 5V$				
Power MC	SFET						
		$V_{IN} = 2.5V, I_{C}$	<sub>DUT</sub> = 350mA		100	177	
R <sub>DS(ON)</sub>	Switch On Resistance	V <sub>IN</sub> = 3.3V, I <sub>OUT</sub> = 350mA			85	145	mΩ
		V <sub>IN</sub> = 5V, I <sub>OUT</sub>	r = 350mA		75	125	
I <sub>LKG</sub>	Output Leakage Current	Switch Off, V <sub>OUT</sub> = 0V			0.22	15	μA

#### Notes:

- 4. Exceeding the absolute maximum ratings may damage the device.
- 5. The device is not guaranteed to function outside its operating ratings.
- 6. Devices are ESD sensitive. Handling precautions are recommended. Human body model, 1.5kΩ in series with 100pF.
- 7. Specification for packaged product only

# **Electrical Characteristics**<sup>(7)</sup> (Continued)

 $V_{IN} = V_{EN} = 5V$ ;  $C_{IN} = 1\mu F$ ;  $C_{OUT} = 1\mu F$   $T_J = 25^{\circ}C$ . **Bold** values indicate  $-40^{\circ}C \le T_J \le +125^{\circ}C$ , unless noted otherwise.

Symbol	Parameter	Condition		Тур.	Max.	Units	
Current Lii	mit						
		$R_{LIMIT} = 115\Omega$ , $V_{IN} = 5V$ , $V_{OUT} = 0.8V \times V_{IN}$	2.35	2.35 2.5 2.65			
		$R_{LIMIT} = 115\Omega, V_{IN} = 2.5V, V_{OUT} = 0V$	2.6	2.85	3.1	i	
	Current Limit	$R_{LIMIT} = 145\Omega$ , $V_{IN} = 5V$ , $V_{OUT} = 0.8V \times V_{IN}$	1.90	2.0	2.10		
I <sub>LIMIT</sub>	(Resistor values are standard 0.1% values)	$R_{LIMIT} = 287\Omega$ , $V_{IN} = 5V$ , $V_{OUT} = 0.8V \times V_{IN}$	0.95	1.0	1.05	A   -	
	,	$R_{LIMIT} = 576\Omega$ , $V_{IN} = 5V$ , $V_{OUT} = 0.8V \times V_{IN}$	0.475	0.50	0.525		
		$R_{LIMIT} = 1.45k\Omega$ , $V_{IN} = 5V$ , $V_{OUT} = 0.8V \times V_{IN}$	0.19	0.20	0.21		
I <sub>LIMIT_2nd</sub>	Secondary Current Limit (Kickstart parts only)	V <sub>OUT</sub> = 0V	2.2	3.2	6	А	
I/O	1		•				
.,	F 11 1/16	Logic Low			0.5	.,	
$V_{EN}$	Enable Voltage	Logic High	1.5		V		
I <sub>EN</sub>	Enable Input Current	0V ≤ V <sub>EN</sub> ≤ 5V		1		μA	
R <sub>FAULT/</sub>	FAULT/ Output Resistance	I <sub>OUT</sub> = 10mA			25	Ω	
I <sub>FAULT/_OFF</sub>	FAULT/ Off Current	V <sub>FAULT</sub> / = V <sub>IN</sub>			10	μA	
Thermal P	rotection						
T <sub>SD</sub>	Thermal-Shutdown Threshold	T <sub>J</sub> rising		157		°C	
T <sub>SDHYS</sub>	Thermal-Shutdown Hysteresis			15		°C	
Timing Spe	ecifications (AC Parameters)						
t <sub>RISE</sub>	Output Turn-on Rise Time <sup>(8)</sup>	$R_{LOAD} = 10\Omega$ ; $C_{OUT} = 1\mu F$		700		μs	
t <sub>FALL</sub>	Output Turn-off Fall Time <sup>(8)</sup>	$V_{EN} = OFF; R_{LOAD} = 10\Omega; C_{OUT} = 1\mu F$		32		μs	
t <sub>ON_DLY</sub>	Output Turn-on Delay <sup>(8)</sup>	$R_{LOAD} = 10\Omega$ ; $C_{OUT} = 1\mu F$		700		μs	
t <sub>OFF_DLY</sub>	Output Turn-off Delay <sup>(8)</sup>	$R_{LOAD} = 10\Omega$ ; $C_{OUT} = 1\mu F$		5		μs	
t <sub>SC_RESP</sub>	Short Circuit Response Time <sup>(8)</sup>	V <sub>OUT</sub> = 0V (short circuit)		10		μs	
t <sub>FAULT/</sub>	Overcurrent Fault Response Delay Time <sup>(8)</sup>	Non-Kickstart parts	16	32	49	ms	
t <sub>KICKSTART</sub>	Overcurrent Fault Response Delay During Kickstart <sup>(8)</sup>	Kickstart parts only	64	120	200	ms	

### Note:

<sup>8.</sup> See "Timing Diagrams" (Figures 1 through 4).

## **Timing Diagrams**

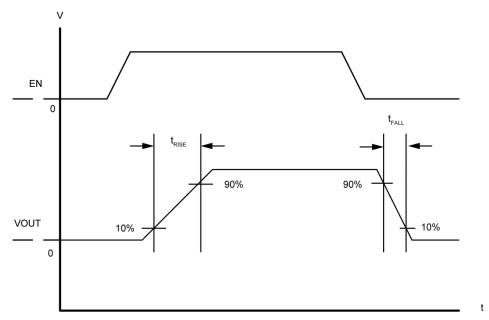


Figure 1. Output Rise/Fall Time

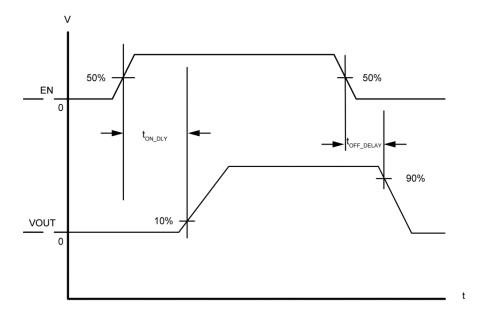


Figure 2. Turn-On/Off Delay

## **Timing Diagrams (Continued)**

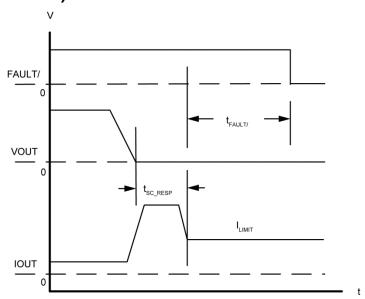


Figure 3. Short Circuit Response Time and Overcurrent Fault Flag Delay (Non-Kickstart)

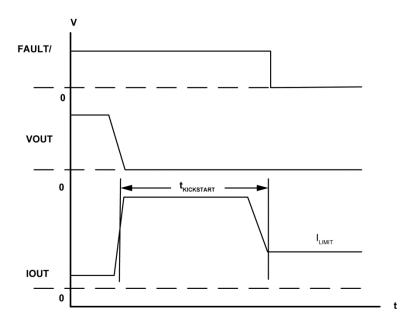
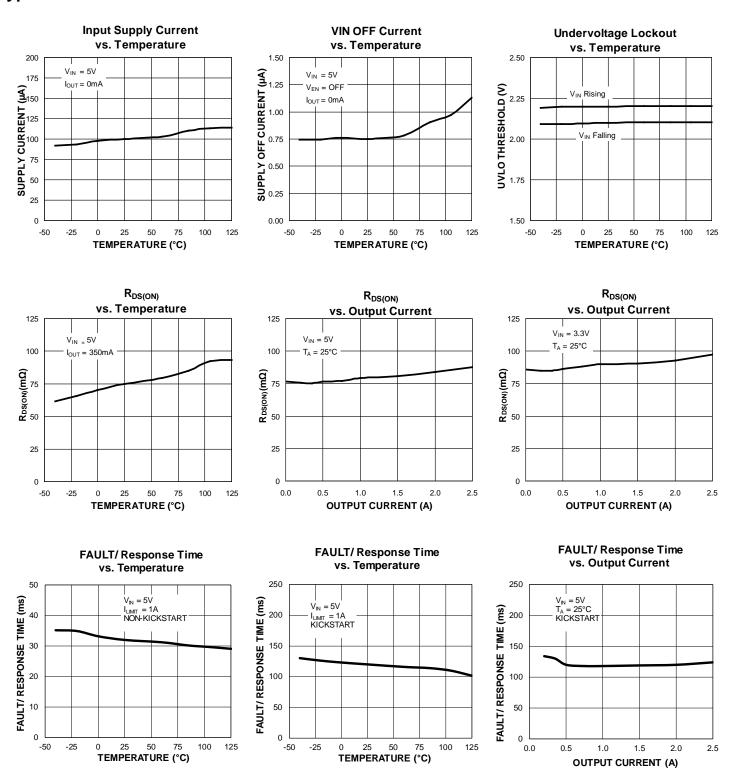
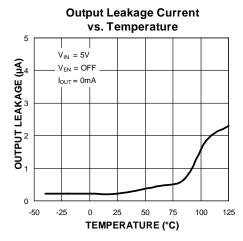


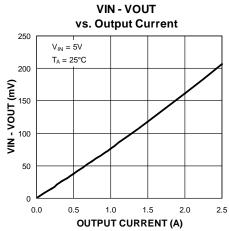
Figure 4. Overcurrent Fault Flag Delay (Kickstart)

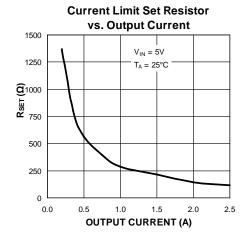
## **Typical Characteristics**



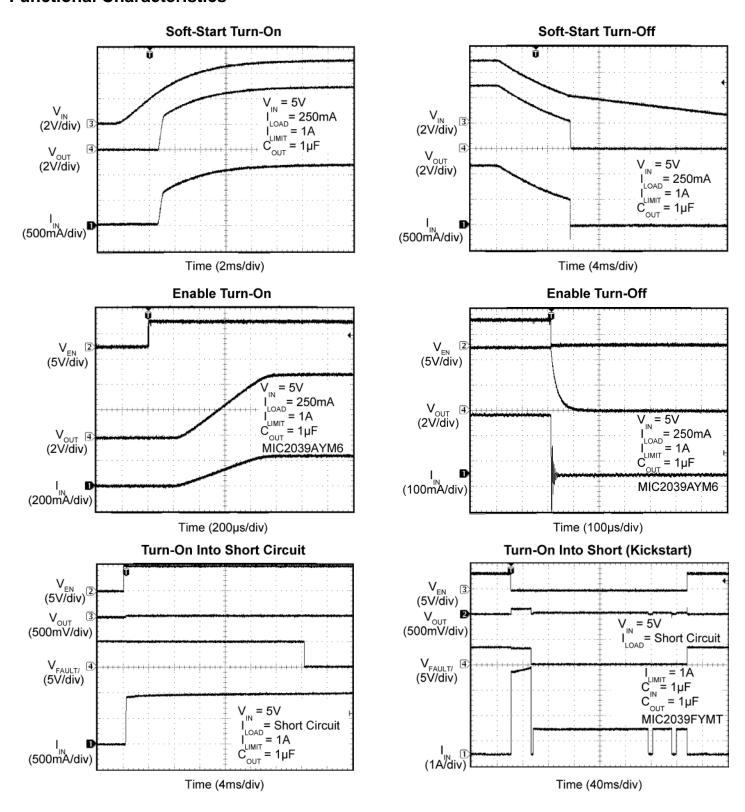
# **Typical Characteristics (Continued)**



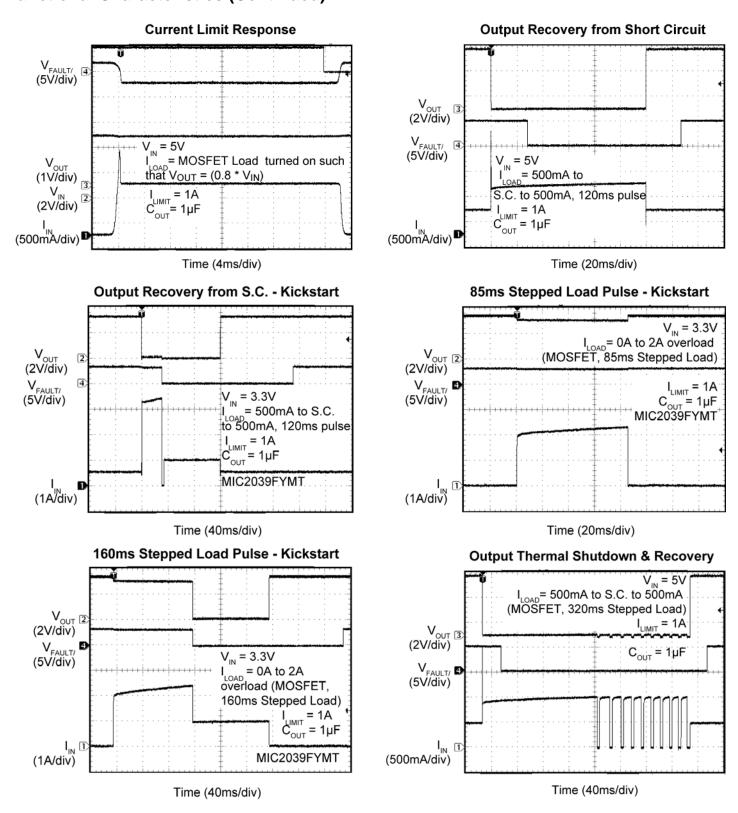




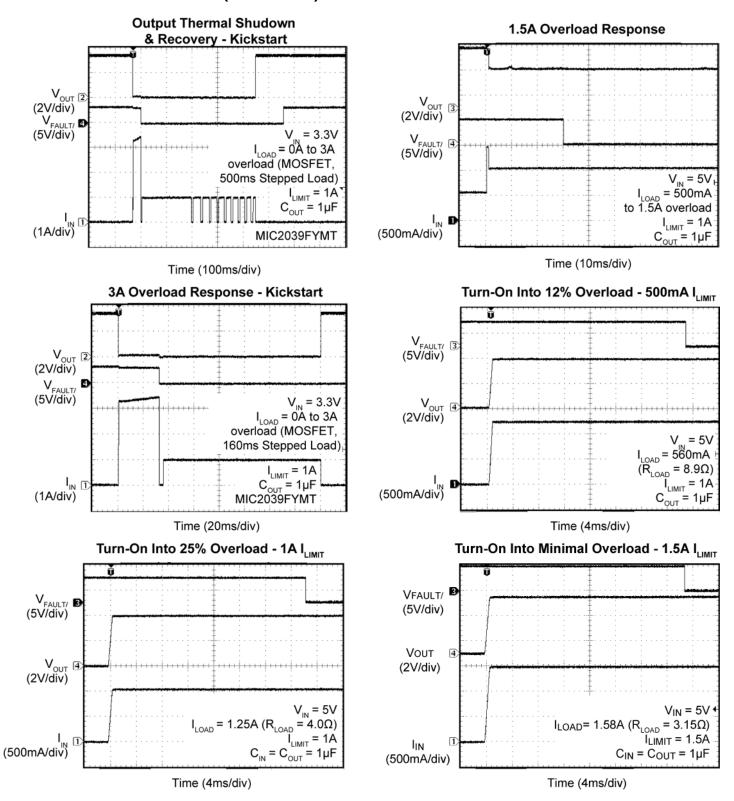
### **Functional Characteristics**



## **Functional Characteristics (Continued)**



## **Functional Characteristics (Continued)**



## **Functional Diagram**

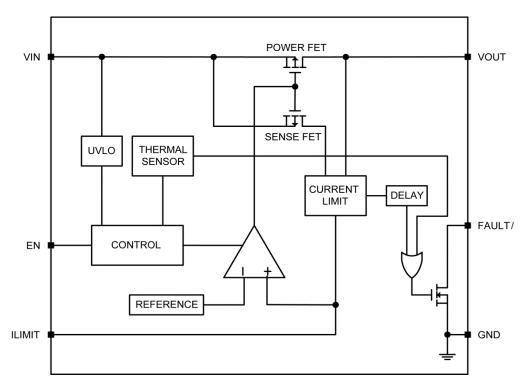


Figure 5. MIC2039 Block Diagram

### **Functional Description**

The MIC2039 is a high-side MOSFET power-distribution switch that provides increased system reliability by using 5% current limit accuracy. The MIC2039 is internally current limited and has thermal shutdown, which protects the device and system.

The MIC2039 has a soft-start circuit that minimizes inrush current by slowing the turn-on time. Additionally, the MIC2039 has an optional Kickstart feature, which momentarily overrides the normal current-limiting function to allow higher inrush and/or transient currents.

### **Soft-Start**

Soft-start reduces the power-supply input surge current at startup by controlling the output voltage rise time. The input surge appears while the output capacitor is charged up. A slower output rise time draws a lower input surge current.

### **KICKSTART Inrush Overcurrent Filter**

The MIC2039EYxx and MIC2039FYxx are equipped with a secondary current limit that allows high inrush current transients to pass for a set period before the primary current-limit circuitry becomes active. The FAULT/ status flag does not assert during the Kickstart period (typically 120ms), which eliminates any false (FAULT/) assertions. The Kickstart function is active during initial startup or while operating in steady state.

### **Input Capacitor**

Micrel recommends a  $1\mu F$  to  $10\mu F$  ceramic input capacitor for most applications.

Place the input capacitor on the same side of the board and next to the MIC2039 to minimize the voltage ringing during transient and short-circuit conditions. Using two vias for each end of the capacitor to connect to the power and ground plane is also recommended.

Micrel recommends X7R or X5R dielectric ceramic capacitors because of their temperature performance. X7R-type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change value by as much as 50% and 60%, respectively, over their operating temperature ranges. To use a ceramic chip capacitor with Y5V dielectric, the value must be much higher than an X7R ceramic or a tantalum capacitor to ensure the same capacitance value over the operating temperature range.

### **Output Capacitor**

The output capacitor type and placement criteria are the same as for the input capacitor. See the "Input Capacitor" section for a detailed description.

#### **Enable**

The MIC2039 offers either an active-high or active-low enable input (EN) that allows ON/OFF control of the switch output. The current through the device reduces to near "zero" when the device is shut down, with only microamperes of leakage current. The EN input can be directly tied to VIN or driven by a voltage that is equal to or less than VIN; do not leave this pin floating.

### **Adjustable Current Limit**

The MIC2039 current limit is adjustable from 0.2A to 2.5A by connecting a resistor from the ILIMIT pin to GND. The following equation determines the resistor:

$$R_{I,IMIT} \cong 289/I_{I,IMIT}$$
 Eq. 1

where  $I_{\text{LIMIT}}$  is the typical current limit from the electrical table. If the output current exceeds the set current limit, the MIC2039 switch enters constant current limit mode. The maximum allowable current limit can be less than the full specified and/or expected current if the MIC2039 is not mounted on a circuit board with sufficiently low thermal resistance. Table 1 shows resistor values (1%) for select current limit settings.

Table 1. Resistor Selection for Adjustable Current Limit

I <sub>LIMIT</sub>	0.2A	0.5A	1.0A	2A	2.5A
R <sub>LIMIT</sub>	1.45kΩ	576Ω	287Ω	145Ω	115Ω

### **High Current Limit Application Considerations**

For higher current applications, a robust circuit design is necessary to avoid part failure due to large voltage and/or current swings. When dealing with fast AC transients at higher current limits, the use of a local bypass capacitor is critical in order to maintain a stable input supply. For proper operation, minimizing stray and/or parasitic inductance from the supply to VIN (of IC) and VOUT (of IC) to the actual load can be achieved through a compact circuit design. Table 2 below lists the recommended input/output capacitors for the higher DC current limit settings:

Table 2. Recommended CIN/COUT vs ILIMIT

I <sub>LIMIT</sub>	*C <sub>IN</sub>	C <sub>OUT</sub>
1A	1μF	10μF
2A	10μF	47µF
2.5A	10μF	47µF

<sup>\*</sup>These recommended values are for wire/traces less than 3 inches from the supply to the input and from the output to the load. For lengthy connections (>6 inches), use a  $4.7\mu F$  ( $I_{LIMIT} = 1A$ ) and  $22\mu F$  ( $I_{LIMIT} > 2A$ ) input capacitor.

### **Thermal Design**

To help reduce the thermal resistance, the ePad (underneath the IC) should be soldered to the PCB ground. The placement of thermal vias either underneath or near the ePad is highly recommended. Thermal design requires the following application-specific parameters:

- Maximum ambient temperature (T<sub>A</sub>)
- Output current (I<sub>OUT</sub>)
- Input voltage (V<sub>IN</sub>)
- Current limit (I<sub>LIMIT</sub>)

When the MIC2039 is in constant current limit mode, it may exceed the overtemperature threshold. If this occurs, the overtemperature condition will shut down the MIC2039 switch and the fault status flag will go active (assert low). After the switch cools down, it automatically turns on again. The user can maximize the MIC2039 power dissipation by either lowering the thermal resistance on the exposed pad (only the DFN package has an exposed pad) on the printed circuit board, or by limiting the maximum allowable ambient temperature.

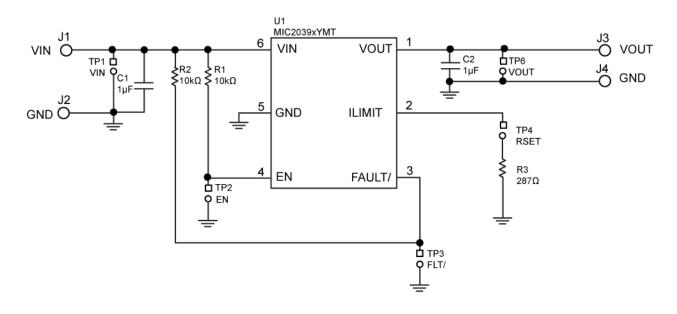
### **Thermal Measurements**

It is always wise to measure the IC's case temperature to make sure that it is within its operating limits. Although this might seem like an elementary task, it is very easy to get false results. The most common mistake is to use the standard thermal couple that comes with the thermal voltage meter. This thermal couple wire gauge is large, typically 22 gauge, and behaves like a heatsink, resulting in a lower case measurement.

There are two suggested methods for measuring the IC case temperature: a thermal couple or an infrared thermometer. If a thermal couple is used, it must be constructed of 36 gauge wire or higher to minimize the wire heatsinking effect. In addition, the thermal couple tip must be covered in either thermal grease or thermal glue to make sure that the thermal couple junction is making good contact to the case of the IC. Thermal couple 5SC-TT-K-36-36 from Omega is adequate for most applications.

To avoid using messy thermal couple grease or glue, an infrared thermometer is recommended. Most infrared thermometers' spot size is too large for an accurate reading on small form factor ICs. However, an IR thermometer from Optris has a 1mm spot size, which makes it ideal for the 2mm  $\times$  2mm thin DFN package. Also, get the optional stand. The stand makes it easy to hold the beam on the IC for long periods of time.

## **Evaluation Board Schematic**



## **Bill of Materials**

Item	Part Number	Manufacturer	Description	Qty.
C1, C2	C1608X5R0J105K	TDK <sup>(9)</sup>	1uE/6 3V coromic conscitor, VER, 0603	
C1, C2	06036D105KAT2A AVX <sup>(10)</sup>		1μF/6.3V ceramic capacitor, X5R, 0603	2
R1, R2	CRCW060310K0FKEA	Vishay/Dale <sup>(11)</sup>	$10k\Omega$ , film resistor, 0603, 1%	2
R3	CRCW06032870FKEA	Vishay/Dale	287Ω film resistor, 0603, 1%	1
U1	MIC2039xYMT	Micrel <sup>(12)</sup>	High-accuracy, high-side, adjustable current-limit power switch	1

### Notes:

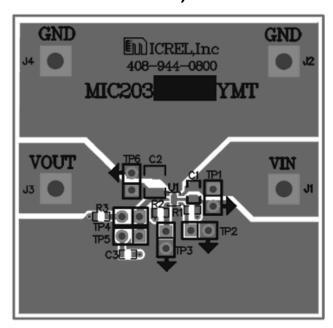
9. TDK: www.tdk.com.

10. AVX.: www.avx.com.

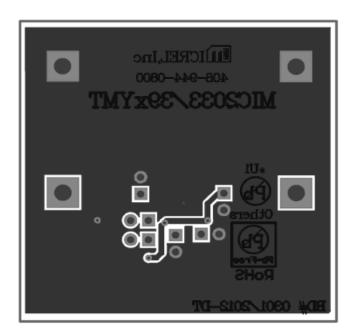
11. Vishay: www.vishay.com.

12. Micrel, Inc.: www.micrel.com.

## PCB Layout (MIC2039xYMT Evaluation Board)

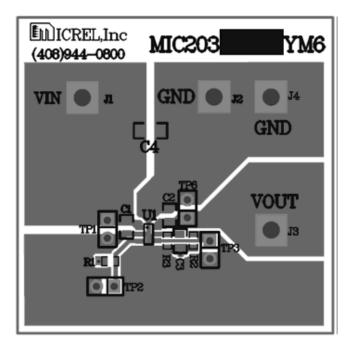


MIC2039xYMT Evaluation Board - Top Layer

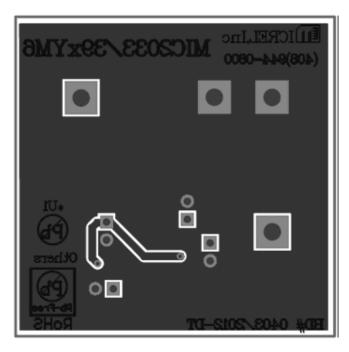


MIC2039xYMT Evaluation Board – Bottom Layer

## PCB Layout (MIC2039xYM6 Evaluation Board)

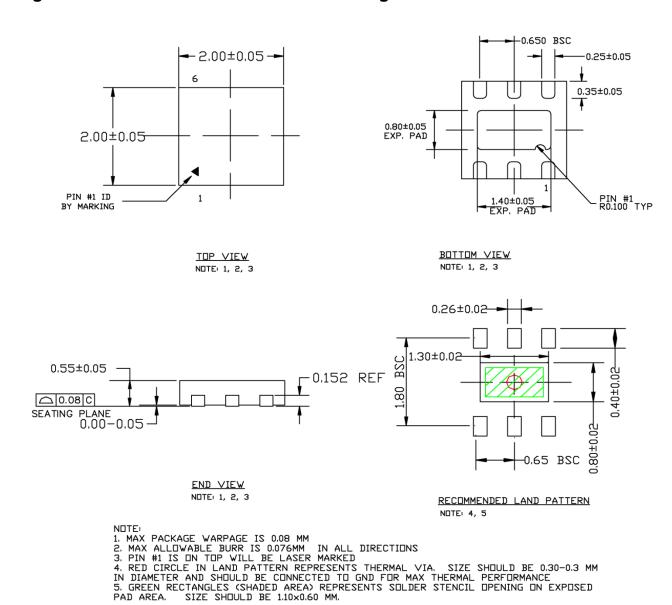


MIC2039xYM6 Evaluation Board - Top Layer



MIC2039xYM6 Evaluation Board – Bottom Layer

# Package Information and Recommended Landing Pattern<sup>(13)</sup>

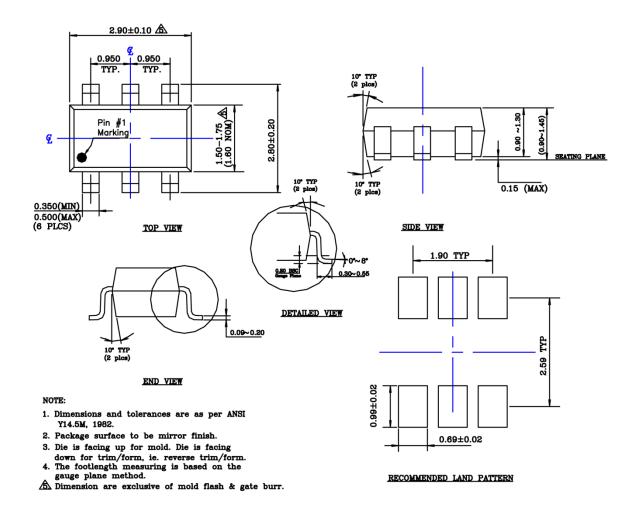


### 6-Pin 2mm x 2mm Thin DFN (MT)

#### Note:

13. Package information is correct as of the publication date. For updates and most current information, go to <a href="www.micrel.com">www.micrel.com</a>.

# Package Information and Recommended Landing Pattern<sup>(13)</sup> (Continued)



SOT23-6L (M6)

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